

## Professional Experience:

*President - Threshold Systems* (www.thresholdsystems.com) 1998 - 2004  
P.O. Box 321, Springdale, Utah, 84767 2007 - present

- Manage a consulting firm which specializes in:
  - technical consulting for client companies regarding Technology Road Maps, identifying research and development opportunities, and preparing research reports on emerging technologies
  - provide advice and resolution strategies to manufacturers on process integration issues and yield optimization
  - expert witness for litigation involving semiconductor processing and IP issues
  - short course technology instruction for engineers and scientists on the subjects of Process Integration, Semiconductor Physics, and Device-Process interactions
  - qualification of semiconductor fabrication facilities for clients as well as yield crisis resolution

### Expert Witness

April 2008 - Oct. 2009

- Acted as the lead expert witness in a multibillion-dollar litigation between two major Asian semiconductor manufacturers
- Conducted a detailed analysis of four generations of process flows to ascertain the veracity of trade secret claims
- Examined in excess of 1,000 papers and patents in a prior art search to establish that certain trade secret claims were publicly available and/or readily ascertainable
- Testified in an eight-hour deposition as well as took the stand for three hours in Federal court in Alameda County California, to opine on the validity of specific trade secret claims

### Baseline Integration Engineer

**Sematech's Advanced Technology Development Center (ATDF)** April 2004 – Jan. 2006

- Managed a 90 nm research baseline and was responsible for leading teams of engineers to resolve all technical issues associated with this process flow and for maintaining the line stability
- Resolved processing issues on a leading-edge high-k/metal gate logic process flow
- Acted as the key development engineer on the ATDF 45 nm development effort, assuming responsibility for engineering the transistor gate stack
- Interfaced with Front End Process R&D on a daily basis and addressed their fabrication concerns, as well as integrated their new process modules into the baseline process

***Instructor - UC Berkeley Extension, College of Engineering*** 1995 - 2004  
**University of California at Berkeley, Berkeley, California**

- A key lecturer for UC Berkeley's public courses on the subjects of Process Integration for the highly acclaimed courses: "Silicon processing for the VLSI Era", "Process Integration for Sub-Micron Technologies"

***Senior Process Integration Engineer***

**Motorola Semiconductor Products Sector, MOS 8, Austin, Texas.** 1994 - 1998

- Orchestrated the transfer of a range of high performance Logic parts featuring embedded Non-Volatile memory elements from Motorola's research facility (APRDL) into a manufacturing environment, and solved numerous process integration problems associated with these devices
- Made numerous presentations to senior management and Design and Process Engineering staffs, as well as directly to customers

***Technology Transfer Device Engineer - Advanced Microcontrollers***

**Motorola Semiconductor Products Sector, MOS 8, Austin, Texas.** 1993 - 1994

- Successfully transferred numerous 16/32-bit microcontrollers and other complex multi-function Logic devices from R&D into high-volume production, and systematically enhanced their yields
- Interfaced with Design, Test, Product Engineering, and Manufacturing, and lead cross-functional groups to resolve technical problems associated with the manufacture of state-of-the-art ICs

***Device Engineer***

**MOS 8 Motorola Semiconductor Products Sector, Austin, Texas.** 1991 - 1993

- Managed the production of a large portfolio of digital/analog Logic devices for Custom Automotive, Telecom, and Advanced Microcontroller Systems
- Designed experiments to isolate and identify the sources of yield loss and conducted failure analysis to successively enhance the yield of these devices

**Education:**

***Master of Science - Semiconductor Physics*** Graduated 1990  
**University of Utah, Salt Lake City, Utah.**

***Bachelor of Science - Science*** Graduated 1984  
**University of Waterloo, Waterloo Ontario, Canada.**

**Special Skills:**

- Excellent communication skills - written and verbal
- Outstanding people skills

**Activities:**

- Technical rock climbing, technical ice climbing, rowing, bicycling, canyoneering

## **Publications: Papers**

- Jerry Healey & Craig Franklin, "**The Prevention of Polyimide Stringers on Bonding Pads**", *Interface '93 Microlithography Seminar Proceedings*; September 1993.
- Jerry Healey & George Kong, "**The Reduction of Low-Level Current Leakage in CMOS Devices**", *Microelectronics Manufacturability, Yield, and Reliability*, October 1994.
- Jerry Healey, Tony Phan & Randy Kent, "**The Prevention of Auto Doping induced Threshold Voltage Shifts**", *SPIE The International Society for optical Engineering*, October 1, 1995.
- Jerry Healey & Tony Phan, "**The Role of RIE in Microchip Bond Pad Corrosion**"; *SPIE The International Society for optical Engineering*, October 16, 1996.
- Jerry Healey & Neil Henis, "**Yield Enhancement Through Monitoring of Real Time Manufacturing Processes**", *Future Fab International*, January 1, 1997.
- Jerry Healey & Scott Rubel, "**The Influence of Topographical Variations on Reliable Via and Contact Formation**", *Microelectronics Manufacturability, Yield, and Reliability*, August 1999.
- Jerry Healey, "**Dual Damascene and Low-K Dielectrics**", web publication, [www.siliconnexus.com](http://www.siliconnexus.com), 2002. (17,000 copies downloaded).

## **Publications CD ROMs:**

- Jerry Healey "**Chemical Mechanical Polishing**", an instructional CD ROM and accompanying course text; *Threshold Systems*, August 2001.

## **Patents:**

- Jerry Healey, David Brady, Todd Rhoad "**A Method for Controlling the Etch Rate of Silicon Dioxide Offset Spacers**"; ATDF Application, 2006.